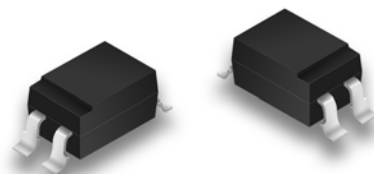


**AB817A-B**

## Photocoupler

**DESCRIPTIONS**

- The AB817A-B (1-channel) is optically coupled isolators containing a GaAs Light Emitting Diode and an NPN silicon phototransistor
- The lead pitch is 2.54mm

**FEATURES**

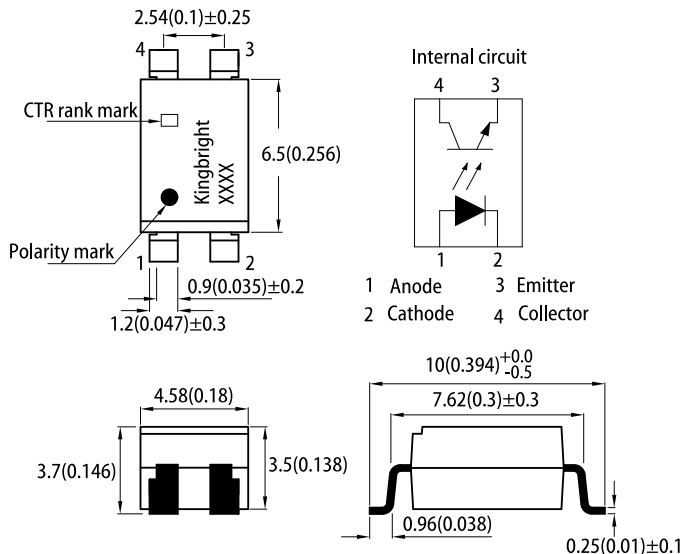
- Lead forming (gull wing) type, for surface mounting
- Maximum working isolation voltage  $V_{IOWM} = 630 V_{RMS}$
- Maximum repetitive peak isolation voltage  $V_{IORM} = 890 V_{peak}$
- Maximum transient isolation voltage  $V_{IOTM} = 7 kV_{peak}$
- Maximum withstanding isolation voltage  $V_{ISO} = 5000 V_{RMS}$
- Compact dual-in-line package AB817A-B:1-channel type
- Recognized by UL and CUL, file NO.E225308
- Package: 1000 pcs / reel
- Moisture sensitivity level: 4
- RoHS compliant

**APPLICATIONS**

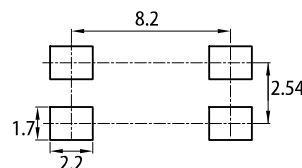
- Computer terminals
- Registers, copiers, automatic vending machines
- System appliances, measuring instruments
- Programmable logic controller
- Signal transmission between circuits of different potentials and impedances

**NOTES ON HANDLING****Cautions regarding electrical noise**

Please ensure the power supply is stable at all times. Even if the designed operating voltage is within specification limits, sudden voltage spikes at startup may damage the component.

**PACKAGE DIMENSIONS****RECOMMENDED SOLDERING PATTERN**

(units : mm; tolerance :  $\pm 0.15$ )

**Notes:**

- All dimensions are in millimeters (inches).
- Tolerance is  $\pm 0.5(0.02")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications.

**ELECTRICAL / OPTICAL CHARACTERISTICS at  $T_A=25^\circ C$** 

Parameter			Symbol	Value			Unit	Test Conditions
				Min.	Typ.	Max.		
Input	Forward Voltage		V <sub>F</sub>	-	1.2	1.4	V	I <sub>F</sub> =20mA
	Peak Forward Voltage		V <sub>FM</sub>	-	-	3.0	V	I <sub>FM</sub> =0.5A
	Reverse Current		I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> =4V
Output	Collector Dark Current		I <sub>CEO</sub>	-	-	10 <sup>-7</sup>	A	I <sub>F</sub> =0mA, V <sub>CE</sub> =20V
Transfer Characteristics	Current Transfer Ratio <sup>[1]</sup>		CTR	80	-	160	%	I <sub>F</sub> =5mA, V <sub>CE</sub> =5V
	Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	-	0.1	0.2	V	I <sub>F</sub> =20mA, I <sub>C</sub> =1mA
	Cut-off Frequency		f <sub>c</sub>	-	80	-	kHz	V <sub>CE</sub> =5V, I <sub>C</sub> =2mA R <sub>L</sub> =100 Ω, -3dB
	Response Time	Rise Tme	t <sub>r</sub>	-	4	18	μs	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA R <sub>L</sub> =100 Ω
		Fall Time	t <sub>f</sub>	-	3	18	μs	

**Notes:**

1. Classification table of current transfer ratio is shown below.

$$CTR = \frac{I_C}{I_F} \times 100\%$$

2. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter		Symbol	Rating	Unit
Input	Forward Current	I <sub>F</sub>	50	mA
	Reverse Voltage	V <sub>R</sub>	6	V
	Power Dissipation	P <sub>D</sub>	70	mW
Output	Collector-Emitter Voltage	V <sub>CEO</sub>	35	V
	Emitter-Collector Voltage	V <sub>ECO</sub>	6	V
	Collector Current	I <sub>C</sub>	50	mA
	Collector Power Dissipation	P <sub>C</sub>	150	mW
Total Power Dissipation		P <sub>tot</sub>	200	mW
Isolation Voltage <sup>[1]</sup>		V <sub>ISO</sub>	5000	V <sub>RMS</sub>
Operating Temperature		T <sub>opr</sub>	-30~+100	°C
Storage Temperature		T <sub>stg</sub>	-55~+125	°C

Notes:  
1. 40 to 60% RH, AC for 1 minute.  
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

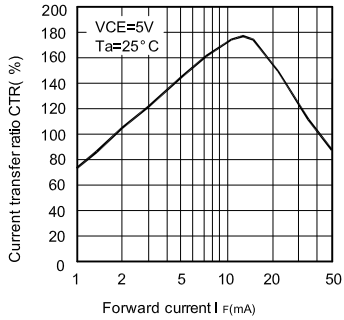
MAXIMUM SAFETY RATINGS

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
Input Current	I <sub>SI</sub>	-	-	300	mA	-
Output Power Dissipation	P <sub>SO</sub>	-	-	500	mW	-
Ambient Safety Temperature	T <sub>S</sub>	-	-	150	°C	-

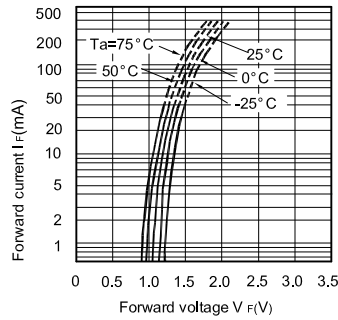
Note:  
1. This optocoupler is designed for electrical isolation only when operating within its specified safety ratings.  
Compliance with these ratings must be guaranteed by implementing appropriate protective circuits.

## TECHNICAL DATA

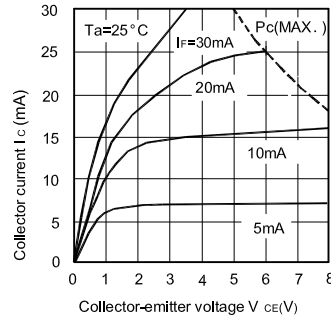
**Fig. 1 Current Transfer Ratio vs. Forward Current**



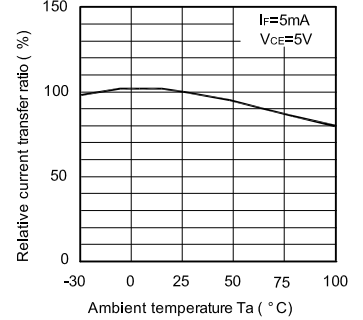
**Fig. 2 Forward Current vs. Forward Voltage**



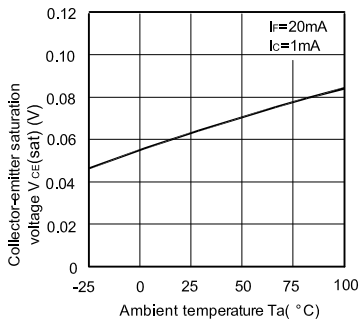
**Fig. 3 Collector Current vs. Collector-Emitter Voltage**



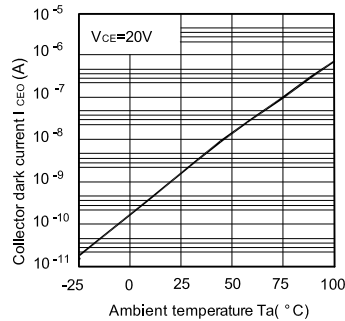
**Fig. 4 Relative Current Transfer Ratio vs. Ambient Temperature**



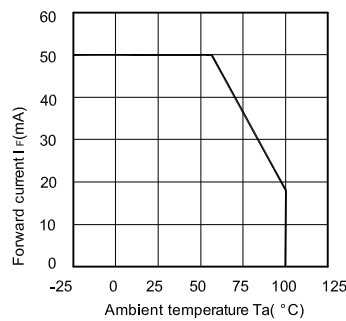
**Fig. 5 Collector-Emitter Saturation Voltage vs. Ambient Temperature**



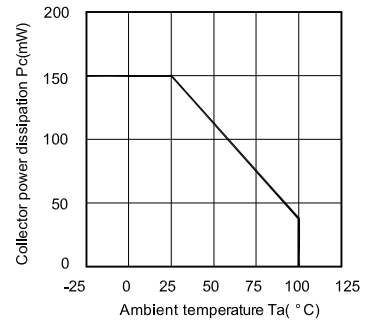
**Fig. 6 Collector Dark Current vs. Ambient Temperature**



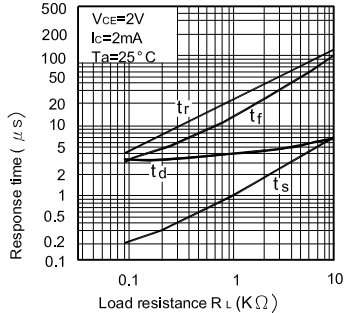
**Fig. 7 Forward Current vs. Ambient Temperature**



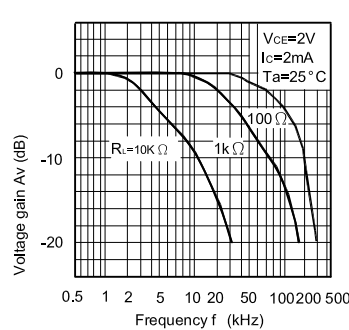
**Fig. 8 Collector Power Dissipation vs. Ambient Temperature**



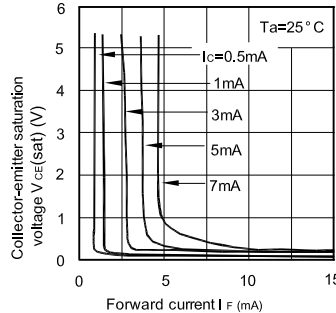
**Fig. 9 Response Time vs. Load Resistance**



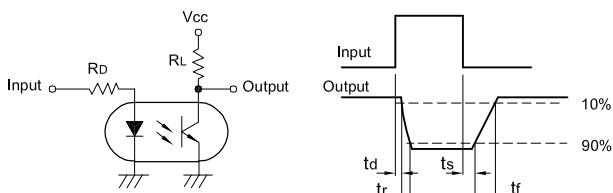
**Fig.10 Frequency Response**



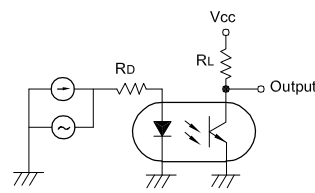
**Fig.11 Collector-Emitter Saturation Voltage vs. Forward Current**



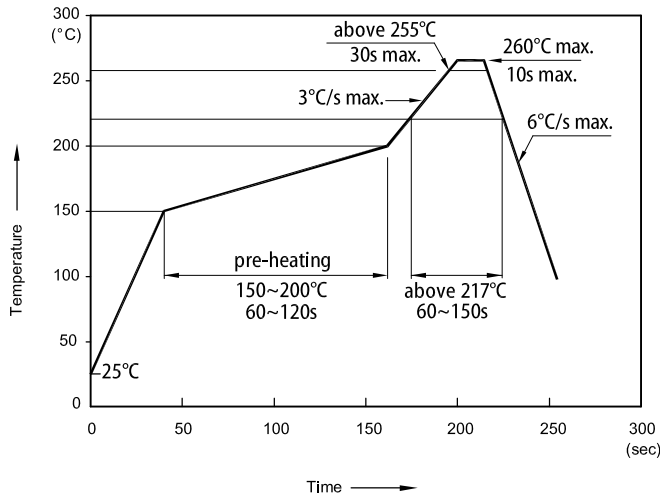
**Test Circuit for Response Time**



**Test Circuit for Frequency Response**

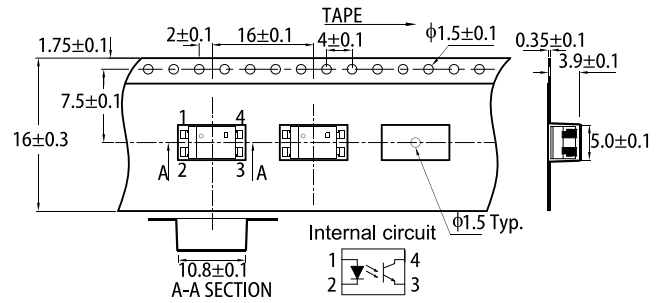


### REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

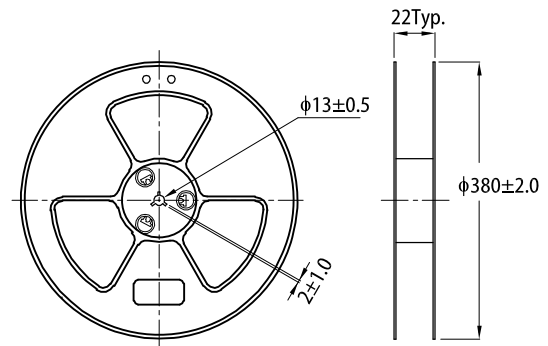


Notes:  
 1. Don't cause stress to the LEDs while it is exposed to high temperature.  
 2. The maximum number of reflow soldering passes is 2 times.  
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

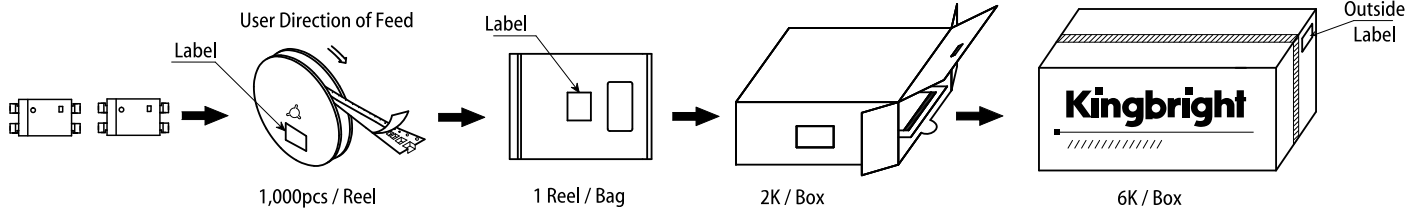
### TAPE SPECIFICATIONS (units : mm)



### REEL DIMENSION (units : mm)



### PACKING & LABEL SPECIFICATIONS



### RESTRICTIONS ON PRODUCT USE

- The information in this document represents typical usage and is provided for technical reference.
- The information in this document is subject to change without notice. Please refer to the latest version of this document for the most updated information.
- Please ensure this product is used in accordance with the electrical and environmental specifications and tolerances listed in this document. If the usage exceeds the specification range, Kingbright will not be responsible for any subsequent issues.
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